



广州市东裕光电科技有限公司

产品规格书

SPECIFICATION

客户名称 CUSTOMER	
产品名称 PRODUCTION	IC 环境光传感器直插 LAMP IC Ambient Light Sensor
产品型号 MODEL	DYWH-ALS-PDIC243-3B
版本号 VERSION NO	A1.0

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DYWH-ALS-PDIC243-3B



产品描述 Descriptions

DYWH-ALS-PDIC243-3B 是一种环境光传感器，它集成了一个光电二极管和一个 DIP 电流放大器 IC 包中。ALS 系列产品很好地有效解决了显示屏背光的省电问题 移动设备，如手机、NB 和 pda。由于红外辐射的高截留率 环境光传感器的光谱响应接近人眼。此外，它是非常适合使用 ALS 产品 opto-switch 应用程序。

●

(The DYWH-ALS-PDIC243-3B is an ambient light sensor, which incorporates a photodiode and a current amplifier IC in DIP

package. ALS series products are a good effective solution to the power saving of display backlighting of mobile appliances, such as the mobile phones, NB and PDAs. Due to the high rejection ratio of infrared radiation, the spectral response of the ambient light sensor is close to human eyes. Also, it is very suitable to use ALS product for opto-switch application.)

产品特性 Features

- 接近人眼特点的光谱响应特性 (Spectral response characteristics approximating the features of human eyes)
- 对红外具有高抑制特性 (Gigapond has high suppression characteristics for infrared)
- 输出电流对光通量的高线性度 (High linearity of output current with respect to luminous flux)
- 用于抗红外干扰类产品，控制昼夜切换，无需加套管，滤波片

(Used for anti-infrared interference products, control day and night switch, no need to add sleeve for anti-infrared interference products, control day and night switch, no need to add casing, filter)

- 无铅 (Pb free)
- 符合 RoHS 要求 (This product itself will remain within RoHS compliant version)

产品应用 Applications

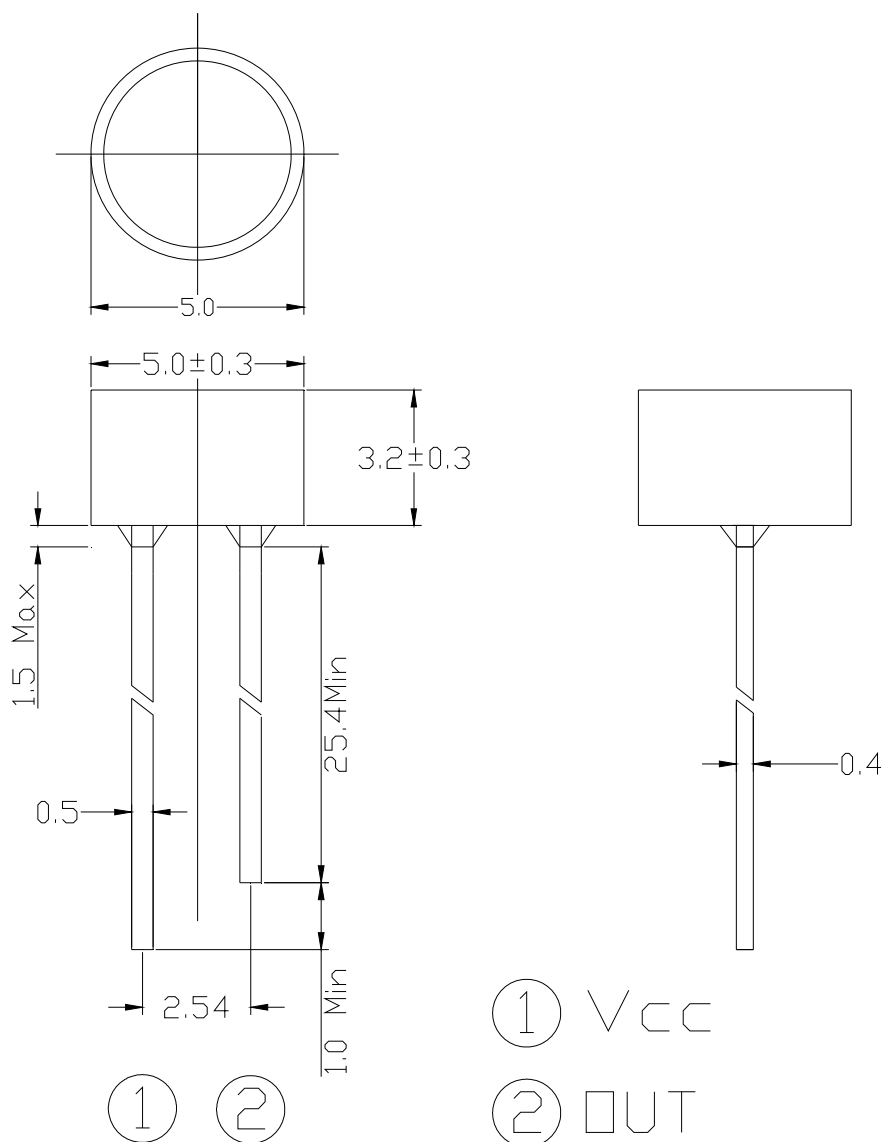
- 安防系统 (Security system.)
- 相机 (Camera)
- 高速光电探测器 (High speed photo detector)

包装方式 Packing Quantity Specification

- 袋装：500PCS/袋，5 袋/小盒，10 小盒/箱(500PCS/1Bag, 5Bags/1Box, 10Boxes/1Carton)



一、外形图 Outline dimensions:



Notes: 1. All dimensions are in mm, tolerance is ± 0.25 unless otherwise noted.

2. An epoxy meniscus may extend about 1.5mm down the leads.

3. Burr around bottom of epoxy may be 0.5mm Max.

单位 Unit	公差 Tolerance	芯片材料 Die material	发光颜色 Emission color	胶体颜色 Lens color
mm	± 0.25 mm	Silicon	—	Black

※备注：承认书之编号和型号可用于查询，客户如有需要，请提供相应的编号和型号。

Remark: P/N & Model in samples approval sheet can be used to inquire, please provide corresponding P/N & model if customer need.



二、光电参数 Electro-Optical Characteristics:

(环境温度 Ambient temperature: 25°C, 环境湿度 Humidity: RH60%)

Parameter	Symbol	MIN	TYP	MAX.	Unit	Test Condition
Dark Current	I_D	---	0.05	0.1	uA	$V_{CC}=3V$, $E_v=0\text{Lux}$
Light Current	I_{PH1}	1	---	3.5	uA	$V_{CC}=3V$, $E_v=10\text{Lux}$ [Note1]
	I_{PH2}	10	---	35	uA	$V_{CC}=3V$, $E_v=100\text{Lux}$ [Note1]
	I_{PH3}	100	---	350	uA	$V_{CC}=3V$, $E_v=1000\text{Lux}$ [Note1]
	I_{PH4}	100	300	---	uA	$V_{CC}=3V$, $E_v=1000\text{Lux}$ [Note2]
Photocurrent Ratio	I_{PH4} / I_{PH3}	---	1.2	---	---	$V_{CC}=3V$, $E_v=1000\text{Lux}$
Peak Sensitivity Wavelength	λ_p	---	560	---	nm	---
Sensitivity Wavelength Range	λ	390	---	700	nm	---
Rise time	t_r	---	0.36	---	ms	$V_{CC} = 3V$ $R_L = 27K\Omega$
Fall time	t_f	---	1.13	---	ms	
Angle of half Sensitivity	$2\theta_{1/2}$	---	143	---	Deg.	$I_F=20\text{mA}$

Note:

1. White Fluorescent light (Color Temperature = 6500K) is used as light source. However, White LED is substituted in mass production.
2. Illuminance by CIE standard illuminant-A / 2856K, incandescent lamp.



三、典型光电特性曲线图 Typical photoelectricity characteristic curve chart:

Fig.1 Light Current vs. Illuminance

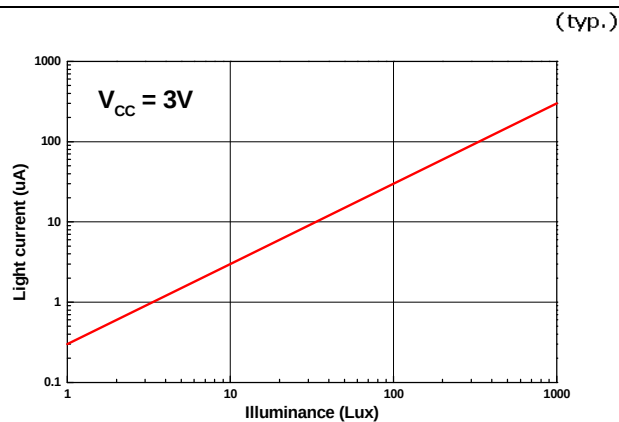


Fig.2 Output Voltage vs. Illuminance

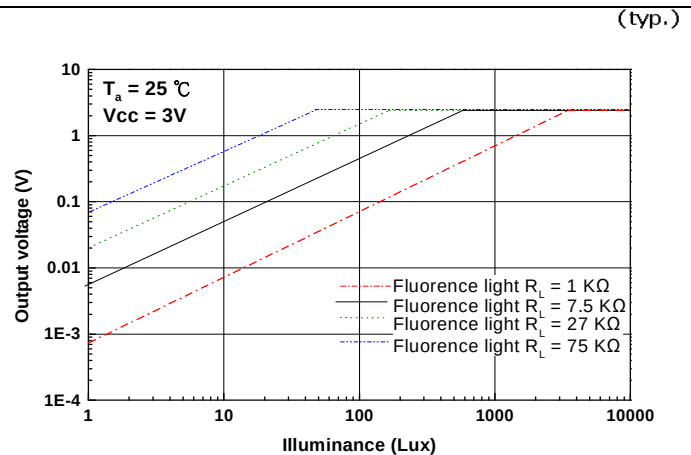


Fig.3 Spectral Response

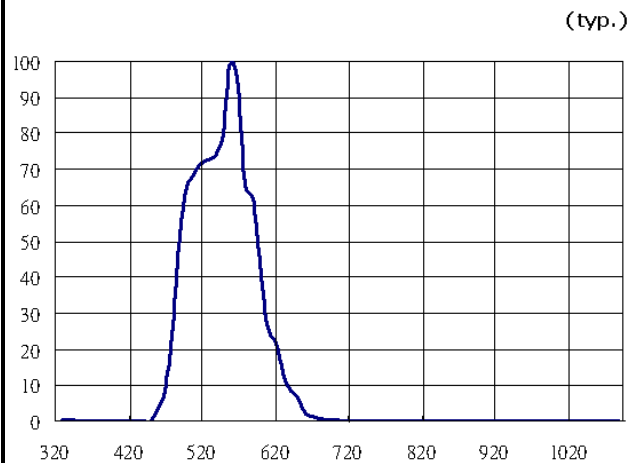


Fig.4 Light current vs. Supply Voltage

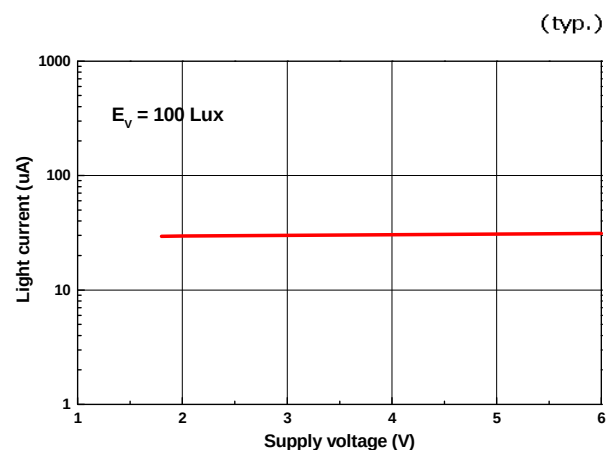


Fig.5 Light Current vs. Temperature

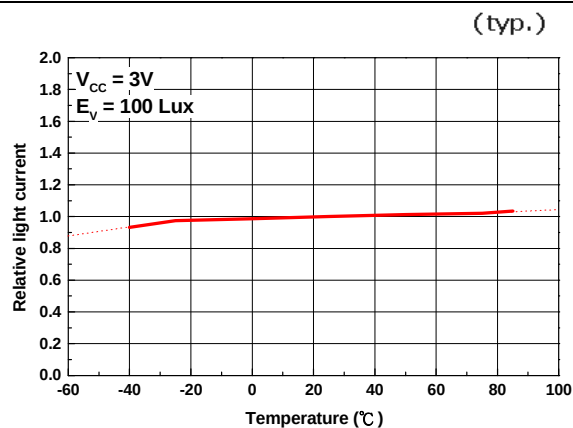
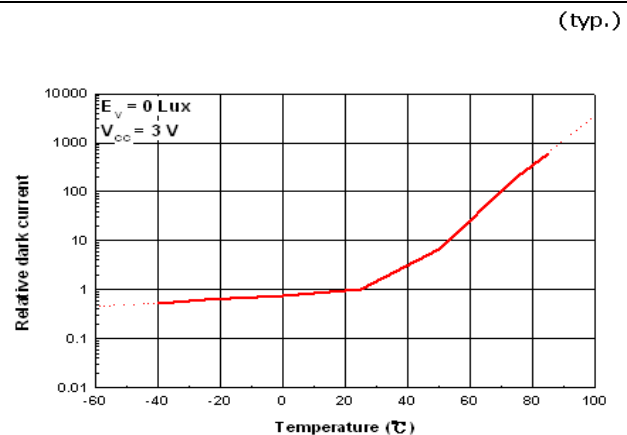


Fig.6 Dark Current vs. Temperature





四、极限参数 Absolute Maximum Rating:

(环境温度 Ambient temperature: 25°C, 环境湿度 Humidity: RH60%)

项目 Item	符号 Symbol	数值 Value	单位 Unit	备注 Remark
工作电压 Supply Voltage	VDD	-0.7~6.5	V	---
工作环境温度范围 Operation temperature Range	Tamb	-40 至+85	°C	---
贮藏温度范围 Storage temperature Range	Tstg	-40 至+100	°C	---
焊接温度 Soldering temperature	Tsol	260	°C	波峰焊, 离环氧体 3mm 处, ≤3S Wave soldering, 3mm out of physical body, ≤3S

五、推荐的操作条件 Recommended Operating Conditions

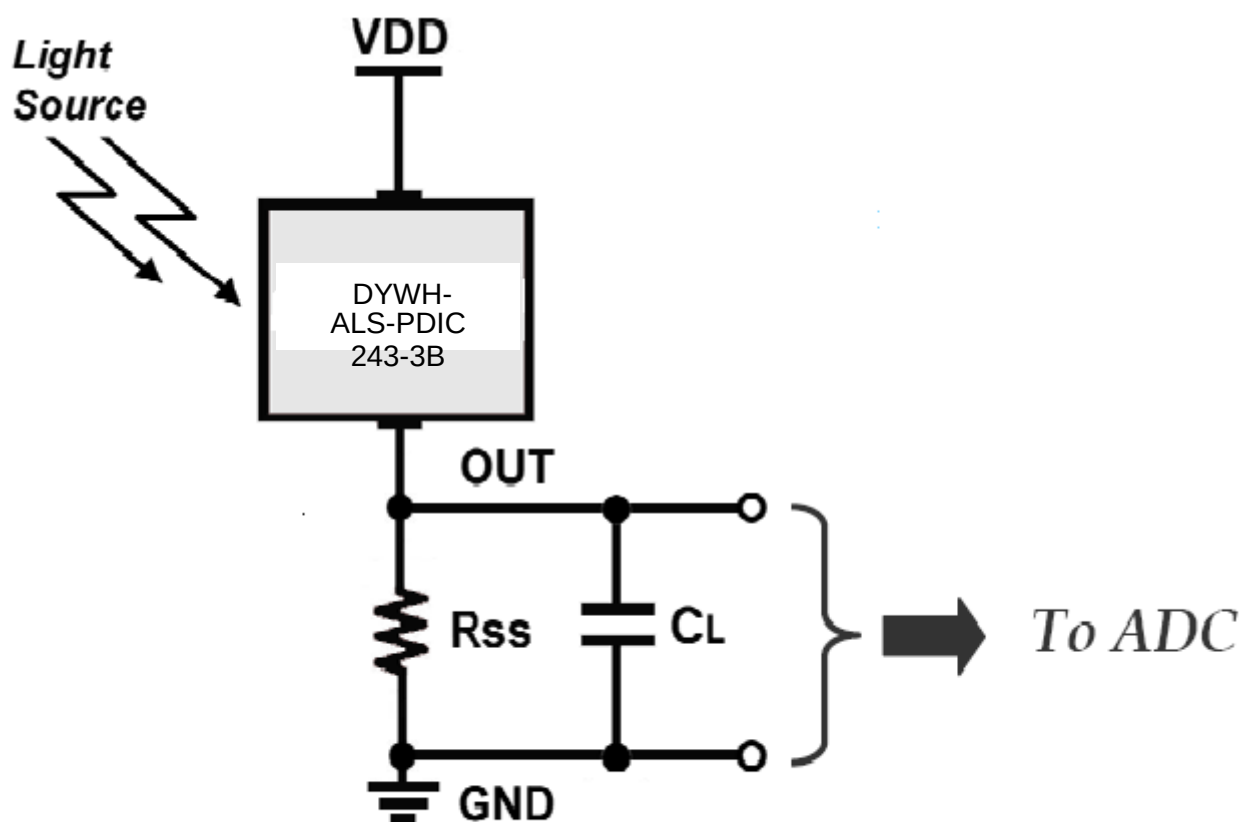
项目 Item	符号 Symbol	最小值 MIN	最大值 MAX	单位 Unit
工作电压 Supply Voltage	VDD	-40	+85	°C
工作环境温度 Operation temperature	Tamb	1.8	5.5	°C

六、可靠性实验项目 Reliability Test Project:

描述 Description	项目 Item	测试标准 Test criterion	测试条件 Test condition	测试时间 Test time	数量 Qty.	失效数量 Fail Qty.
寿命测试 Life test	常温寿命测试 Life test (room temperature)	JIS7021:B4	Ta=25°C±5°C, IF=20mA	1000Hrs	22	0
环境测试 Ambience test	高温存储 High temperature store	JIS7021:B10 MIL-STD-202:210A MIL-STD-750:2031	Ta=85°C±5°C	1000Hrs	22	0
	低温存储 Low temperature store	JIS7021:B12	Ta= -35°C±5°C	1000Hrs	22	0
	高温高湿测试 High temperature/ humidity test	JIS7021:B11 MIL-STD-202:103D	Ta=85°C±5°C RH=85%	1000Hrs	22	0
	冷热冲击测试 Cold / Heat strike test	JIS7021:B4 MIL-STD-202:107D MIL-STD-750:1026	30min -10°C±5°C ↔ 100°C±5°C 5min 5min	50Cycles	22	0
	冷热循环测试 Cold and heat cycle test	JIS7021:A3 MIL-STD-202:107D MIL-STD-705:105E	5min 5min 5min -35°C~25°C~85°C~-35°C 30min 5min 30min 5min	50Cycles	22	0



七、光电流转化为电压 Converting Photocurrent to Voltage



Note:

1. The output voltage (V_{OUT}) is the product of photocurrent (I_{PH}) and loading resistor (R_L)
2. A right loading resistor shall be chosen to meet the requirement of maximum ambient light, and output saturation voltage:

$$V_{OUT(max.)} = I_{OUT(max.)} \times R_L \leq V_{OUT(saturation)} = V_{CC} - 0.4V$$



八、注意事项 Note

1、引脚成形方法 LED bracket forming method

- (1) 必需离胶体 2 毫米才能折弯支架。

The pin of LED can be bent where is at least 2mm out of LED colloid.

- (2) 支架成形必须用夹具或由专业人员来完成。

Must use fixture to deform the LED bracket.

- (3) 支架成形必须在焊接前完成。

Finishing the forming of LED bracket must be before soldering.

- (4) 支架成形需保证引脚和间距与线路板上一致。

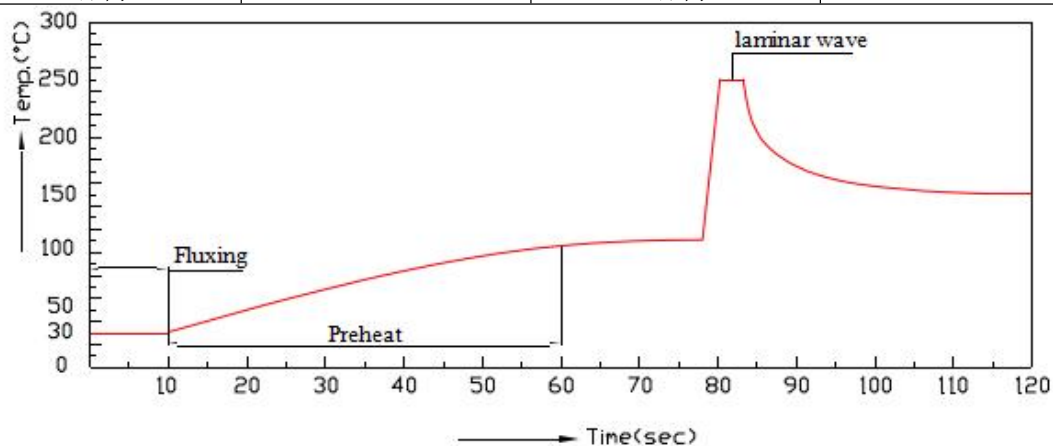
Guarantee the gap between two pin of LED tallys with LED pads in PCB when forming.

2、烙铁焊接 Manual soldering

烙铁（最高 30W）尖端温度不超过 300℃；焊接时间不超过 3 秒；焊接位置至少离胶体 3 毫米。

The tip temperature of soldering iron don't exceed 300℃; soldering time don't exceed 3s and soldering position must be 3mm out of led colloid.

Hand Soldering 手工焊接		DIP Soldering 浸焊	
Temp. at tip of iron 尖端温度	300℃ Max. (30W Max.)	Preheat temp. 预热温度	100℃ Max. (60 sec Max.)
Soldering time 焊接时间	3 sec Max.	Bath temp. & time 炉温&时间	260 Max., 5 sec Max
Distance 距离	3mm Min. (From solder joint to epoxy bulb)	Distance 距离	3mm Min. (From solder joint to epoxy bulb)



3、防静电 ESD

countermeasure

静电及高压会对 LED 造成损坏，特别是芯片材质为 InGaN 的产品对静电防护要求更加严格，要求在使用和检验产品时戴防静电手腕带或防静电手套，焊接工具及设备外壳需可靠接地，焊接条件遵循此份规格书中的条件。

Static electricity and high volt can damage LED, The production whose Die material is InGaN must strictly required to prevent ESD, Must put on static glove and static fillet, Soldering tool and the cover of device must connect the

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ground, soldering condition follows the related stating of production specification manual.

4、过电流保护 Protecting countermeasure when over current

为避免由于电压的变化引起大电流冲击而造成产品损坏，需要加入保护电阻。

Need add the protecting resistor in circuit in order to avoid damaging led due to big current and voltage fluctuation.

5、LED 安装方法 LED installation method

- (1) 注意各类器件外线的排列以防极性装错，器件不可与发热组件靠得太近，工作条件不要超过其规定的极限。

Pay attention to the LED polarity and avoid installation wrong. LED can't be close to eutermic component, work condition should tally with it's specification.

- (2) 务必不要在引脚间距变形的情况下安装 LED。

Don't install the LED under the condition of the led pin deformation.

- (3) 当装配 LED 进入 PCB 或装配孔时，LED 支架不能承受任何压力。

The LED bracket don't load any pressure when installing the LED into PCB or fitting hole.

- (4) 在焊接温度回到正常以前，必须避免使 LED 受到任何的震动或外力。

Must avoid any strike and force on LED before the soldering temperature return to room temperature.

6、存储时间 Storage time

- (1) 在温度 5°C~35°C，湿度 RH60%条件下，产品可保存一年。超过保存期的产品需重新检测后方能使用。

LED can be stored for a year under the condition: the temperature of 5°C~35°C and humidity of RH60%, These production must be re-inspected and tested before use if their storage time exceed a year.

- (2) 如果打开的产品在 5°C~35°C，RH60%的空气条件下放置超过一周，则需要将产品在 65°C±5°C的环境中放置 24 小时以上，并尽量在十五天内使用。

If LED is exposed in air for a week under the condition: the temperature of 5°C~35°C, humidity of RH60%, must place the LED in the ambience of 65°C±5°C for 24 hours and use it in 15 days for best.

7、清洗 Cleaning

当用化学用品清洗胶体时必须特别小心，因为有些化学品对胶体表面有损伤并引起褪色如三氯乙烯、丙酮等。可用乙醇擦拭、浸渍，时间在常温下不超过 3 分钟。

Be careful of some chemical results in the LED colloid fades and damage when using chemical clean the LED, such as chloroethylene, acetone etc. Can use ethanol to wash or soak LED but the time don't exceed 3 minutes.

8、弯脚 Kinked

当 LED 成形弯脚时，弯脚模具容易刮花 LED 脚支架镀层，刮伤处容易生锈，特别是空气湿度大时。为减少生锈机会，建议使用镀锡支架。

The kinked tooling scrape easily the pin of LED, where the LED bracket is rusting easily, especial expose it in moist air. To decrease the LED bracket rust, advise using plated tin LED bracket.